

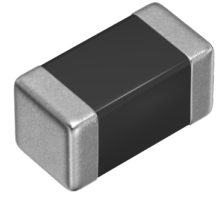
Applications Commercial Grade

Applications Detail Audio Line

Feature For Bluetooth Band
 For WiFi Band

Series MAF

Status Production



Size

Length(L)	0.60mm ±0.03mm
Width(W)	0.30mm ±0.03mm
Thickness(T)	0.33mm Max.
Recommended Land Pattern (A)	0.25mm Nom.
Recommended Land Pattern (B)	0.30mm Nom.
Recommended Land Pattern (C)	0.30mm Nom.

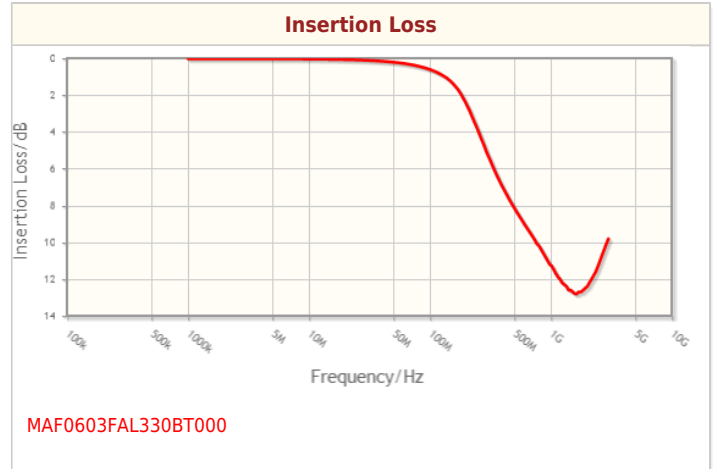
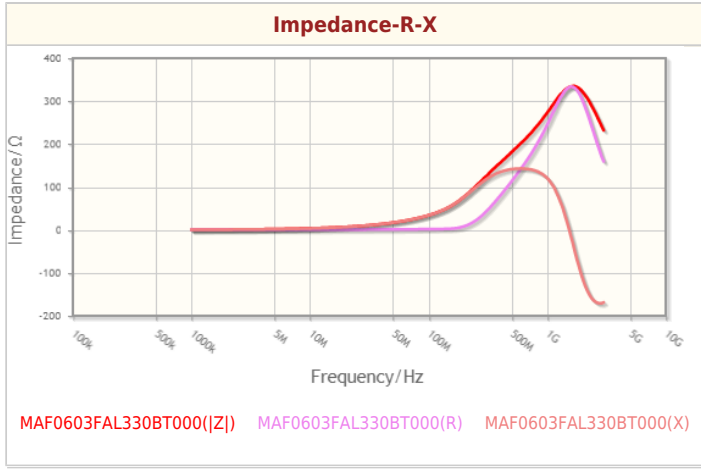
Electrical Characteristics

Impedance (Typ.) at 1MHz	
Impedance (Typ.) at 100MHz	33Ω
Impedance (Typ.) at 900MHz	
Impedance (Typ.) at 1.7GHz	
Rated Current	200mA
DC Resistance (Typ.)	
DC Resistance (Max.)	700mΩ

Other

Operating Temp. Range (Including Self-Temp. Rise)	-55 to 125°C
Soldering Method	Reflow Iron Soldering
Packing	Taping [180mm Reel, Tape width 8mm]
Package Quantity	15000pcs
Weight	0.0003g

Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



! Images are for reference only and show exemplary products.
! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.

Associated Images

